

/ Descriptions

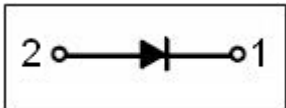
/ Features

Low positive pressure drop, HF Product.

/ Applications

Schottky diode.

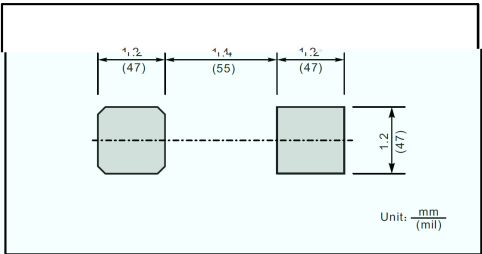
/ Equivalent Circuit



/ Pinning



The recommended mounting pad size



/ h_{FE} Classifications & Marking

/ Absolute Maximum Ratings(Ta=25)

	θ		

/ Electrical Characteristics(Ta=25)

Electrical Characteristic Curve

Fig.1 Power Derating Curve

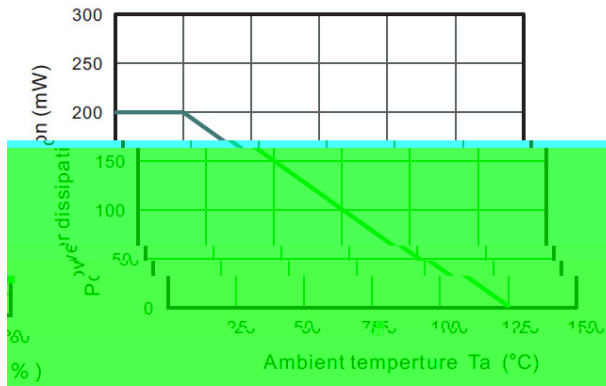


Fig.2 Typical Reverse Characteristics

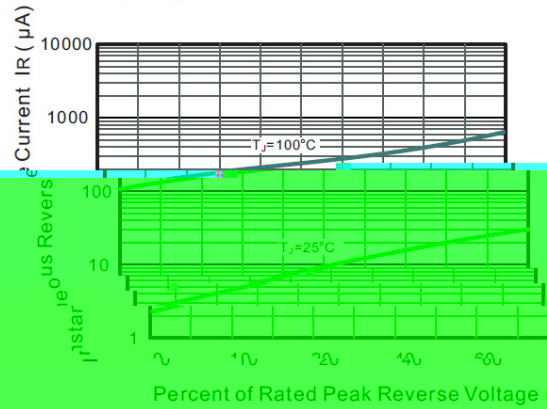


Fig.3 TYPICAL FORWARD VOLTAGE

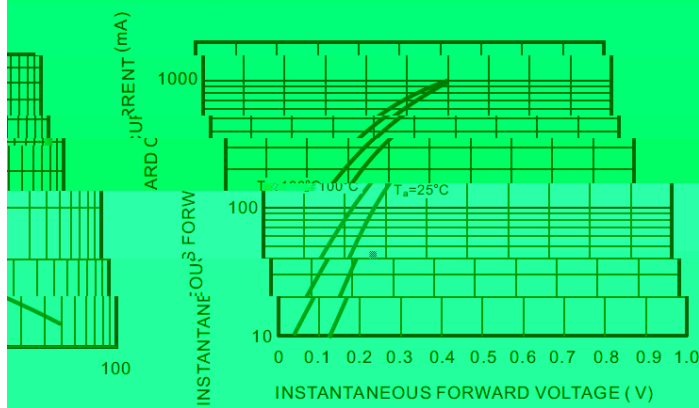


Fig.4 Typical Junction Capacitance

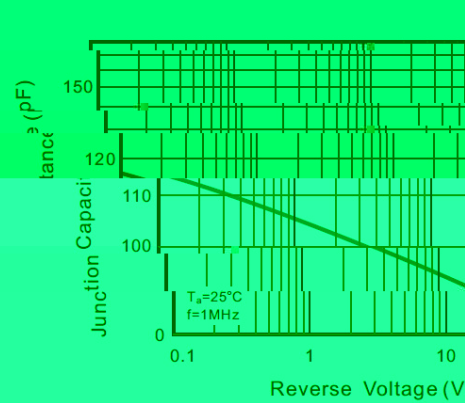
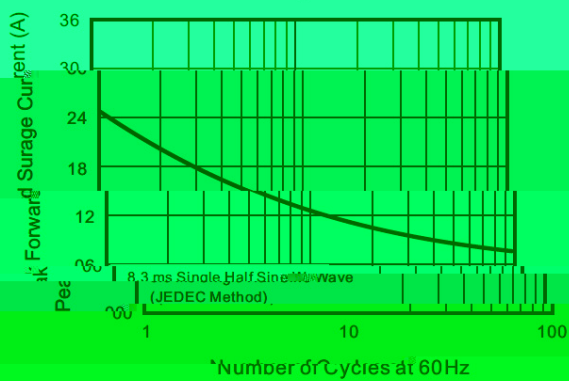
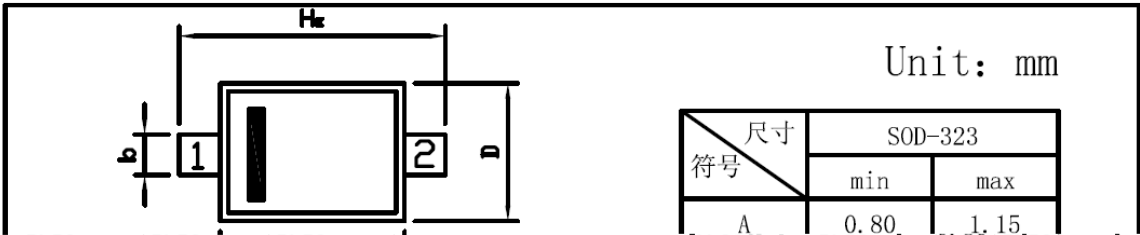


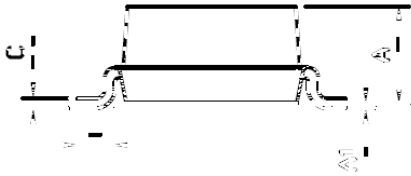
Fig.5 Maximum Non-Repetitive Peak Forward Surge Current



/ Package Dimensions



A1	0.60	0.20
b	0.25	0.40
C	0.08	0.18
D	1.20	1.40
E	1.40	1.80
HE	2.50	2.80
L	0.20	0.45

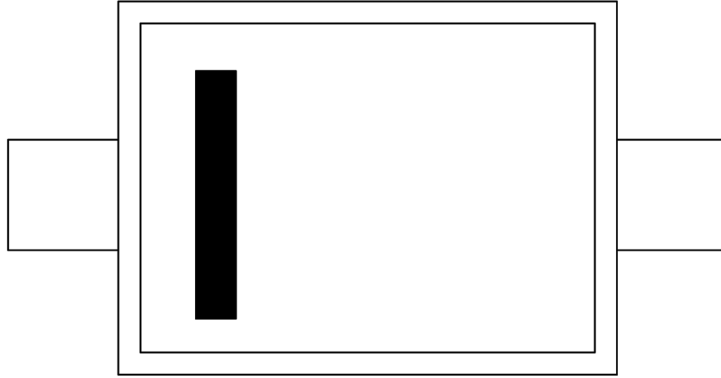


PIN 1 CAUTION 2 AN

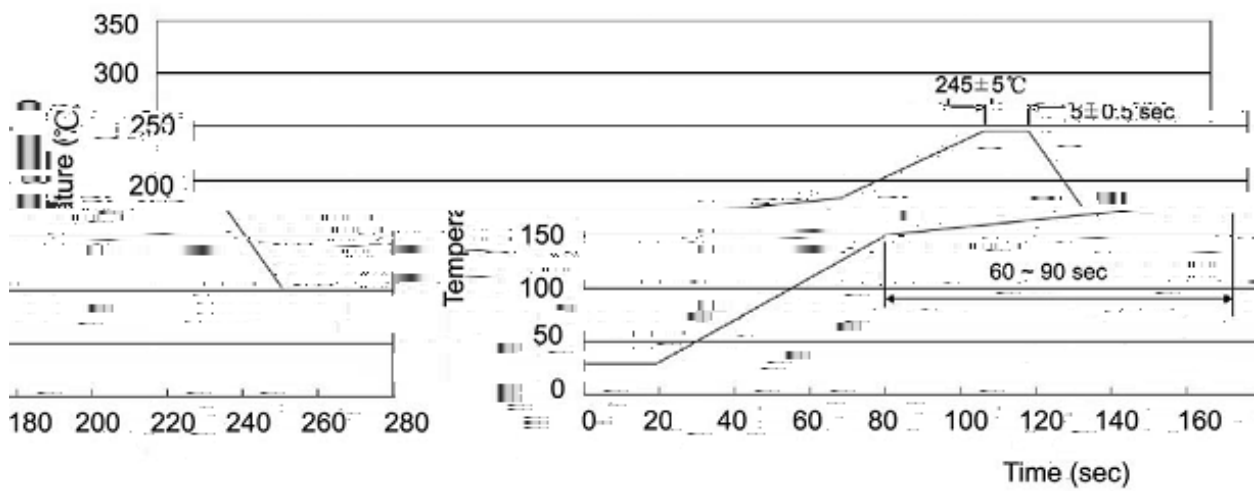
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S 3-3

/ Marking Instructions



() / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ± ± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOD-323	3,000	10	30,000	6	180,000	7 ×8	180×120×180	390×385×205